Application No.: 10/521,544 Docket No.: 08228/071001

AMENDMENTS TO THE CLAIMS

Please amend the claims as follows.

- (Currently Amended) A gallium nitride (GaN)-based compound semiconductor device, comprising:
 - a GaN-based light emitting member;
 - a buffer layer adjacent to the light emitting member; and
 - a strained layer superlattice (SLS) clad layer,
 - wherein the light emitting member comprises a multilayer quantum well structure including an InGaN well layer and an AlInGaN barrier layer,
 - wherein a compositional ratio of Al in the AllnGaN barrier layer is 14% or greater and 40% or smaller, and a compositional ratio of In in the AllnGaN barrier layer is 0.1% or greater and 5% or smaller, and
 - wherein the GaN-based light emitting member emits ultraviolet light having a wavelength of 375 nm or shorter.
- (Previously Presented) The GaN-based compound semiconductor device according to claim
 1, wherein a compositional ratio of In in the InGaN well layer is 5% or greater and 15% or smaller.
- (Previously Presented) The GaN-based compound semiconductor device according to claim
 1, wherein a compositional ratio of In in the InGaN well layer is 5% or greater and 13% or
 smaller.
- (Previously Presented) The gallium nitride (GaN)-based compound semiconductor device according to claim 1,
 - wherein a thickness of the InGaN well layer is 1 nm or greater and 2 nm or smaller.
- (Previously Presented) The GaN-based compound semiconductor device according to claim 4, wherein the thickness of the InGaN well layer is between 1.3 nm and 1.8 nm.

2

423716

Application No.: 10/521,544 Docket No.: 08228/071001

6. (Canceled)

(Currently Amended) The GaN-based compound semiconductor device according to claim 1
[[6]], wherein a compositional ratio of Al in the AlInGaN barrier layer is between 16% and
40%, and a compositional ratio of In in the AlInGaN barrier layer is between 0.1% and 3%.

- (Previously Presented) The GaN-based compound semiconductor device according to claim
 wherein the buffer layer adjacent to the light emitting member is an AlInGaN buffer layer.
- (Currently Amended) A gallium nitride (GaN)-based compound semiconductor device, comprising:
 - a GaN-based light emitting member;
 - an AlInGaN buffer layer adjacent to the light emitting member; and
 - a strained layer superlattice (SLS) clad layer,
 - wherein the light emitting member comprises a multilayer quantum well structure including at least one InGaN well layer and at least one AlInGaN barrier layer, [[and]],
 - wherein a compositional ratio of Al in the AlInGaN buffer layer is 0.5% or greater and 40% or smaller, and a compositional ratio of In in the AlInGaN buffer layer is 0.1% or greater and 5% or smaller,
 - wherein a compositional ratio of Al in the AlInGaN barrier layer is 14% or greater and
 40% or smaller, and a compositional ratio of In in the AlInGaN barrier layer is
 0.1% or greater and 5% or smaller, and
 - wherein the GaN-based light emitting member emits ultraviolet light having a wavelength of 375 nm or shorter.
- 10. (Previously Presented) The GaN-based compound semiconductor device according to claim 9, wherein a compositional ratio of Al in the AlInGaN buffer layer is between 1% and 40%, and a compositional ratio of In in the AlInGaN buffer layer is between 0.1% and 3%.

423716 3

Application No.: 10/521,544 Docket No.: 08228/071001

11. (Previously Presented) The GaN-based compound semiconductor device according to claim 1, wherein the InGaN well layer and the AlInGaN barrier layer are formed at a temperature of 750° C or greater.

12. (Canceled)

- 13. (Currently Amended) The GaN-based semiconductor compound semiconductor device according to claim 1, wherein the SLS clad layer is an n-clad layer.
- 14. (Previously Presented) The GaN-based semiconductor compound semiconductor device according to claim 13, wherein the SLS clad layer comprises alternately layered n-GaN and n-AlGaN.
- 15. (Previously Presented) The GaN-based semiconductor compound semiconductor device according to claim 13, further comprising a p-type SLS clad layer.

16. (Canceled)

423716 4